

3-Phase Inverter Automotive Power Module FTCO3V455A1

General Description

The FTCO3V455A1 is a 40 V low R_{DS(ON)} automotive qualified power module featuring a 3–phase MOSFET inverter optimized for 12 V battery systems. It includes a precision shunt resistor for current sensing an NTC for temperature sensing and an RC snubber circuit.

The module utilizes **onsemi**'s trench MOSFET technology and it is designed to provide a very compact and high performance variable speed motor drive for applications like electric power steering, electro—hydraulic power steering, electric water pumps, electric oil pumps. The power module is 100% lead free, RoHS and UL compliant.

Features

- 40 V 150 A 3-phase Trench MOSFET Inverter Bridge
- 1% Precision Shunt Current Sensing
- Temperature Sensing
- DBC Substrate
- 100% Lead Free and RoHS Compliant with 2000/53/C Directive
- UL94V-0 Compliant
- Isolation Rating of 2500 V rms/min
- Mounting Through Screws
- Automotive Qualified

Benefits

- Low Junction-sink Thermal Resistance
- Low Inverter Electrical Resistance
- High Current Handling
- Compact Motor Design
- Highly Integrated Compact Design
- Better EMC and Electrical Isolation
- Easy and Reliable Installation
- Improved Overall System Reliability

Applications

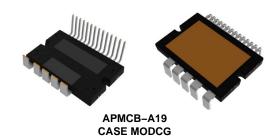
- Electric and Electro-Hydraulic Power Steering
- Electric Water Pump
- Electric Oil Pump
- Electric Fan

Flammability Information

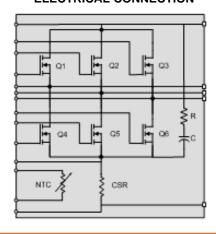
 All Materials Present in the Power Module Meet UL Flammability Rating Class 94 V-0 or Higher

Solder

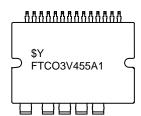
• Solder Used is a Lead Free SnAgCu Alloy



ELECTRICAL CONNECTION



MARKING DIAGRAM



\$Y FTCO3V455A1 = ON Semiconductor

= Specific Device Code

ORDERING INFORMATION

See detailed ordering and shipping information on page 8 of this data sheet.

ABSOLUTE MAXIMUM RATINGS ($T_J = 25^{\circ}C$, Unless Otherwise Specified)

Symbol	Parameter	Rating	Unit	
V _{DS} (Q1~Q6)	Drain to Source Voltage	40	V	
V _{GS} (Q1~Q6)	Gate to Source Voltage		V	
I _D (Q1~Q6)	Drain Current Continuous (T _C = 25°C, V _{GS} = 10 V)	150	Α	
E _{AS} (Q1~Q6)	Single Pulse Avalanche Energy (Note 1)	947	mJ	
P _D	Power Dissipation	115	W	
TJ	Maximum Junction Temperature	175	°C	
T _{STG}	Storage Temperature	125	°C	

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

THERMAL RESISTANCE

Symbol	Parameter	Min.	Тур.	Max.	Unit
Rthjc	Q1 Thermal Resistance J –C	_	0.8	1.1	°C/W
Thermal Resistance Junction to case, Single Inverter FET, chip center (Note 2)	Q2 Thermal Resistance J –C	-	0.8	1.1	°C/W
	Q3 Thermal Resistance J –C	-	0.8	1.1	°C/W
	Q4 Thermal Resistance J –C	-	0.8	1.1	°C/W
	Q5 Thermal Resistance J -C	-	0.8	1.1	°C/W
	Q6 Thermal Resistance J -C	-	0.8	1.1	°C/W
T _J	Maximum Junction Temperature	-		175	°C
T _S	Operating Sink Temperature	-40		120	°C
T _{STG}	Storage Temperature	-40		125	°C

Starting T_J = 25°C, V_{DS} = 20 V, I_{AS} = 64 A, L = 480 μH.
 These values are based on Thermal simulations and PV level measurements.

These values assume a single MOSFET is on, and the test condition for referenced temperature is "Chip Center".

This means that the DT is measured between the T_J of each MOSFET and the temperature of the case located immediately under the center of the chip.

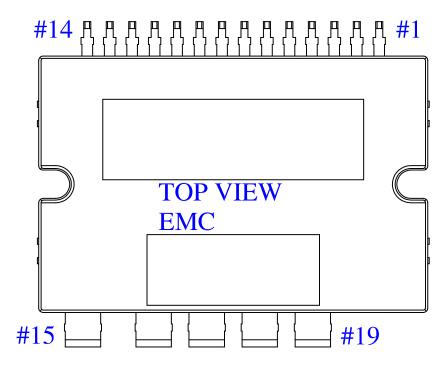


Figure 1. Pin Configuration

PIN DESCRIPTION

Pin Number	Pin Name	Pin Descriptions
1	TEMP 1	NTC Thermistor Terminal 1
2	TEMP 2	NTC Thermistor Terminal 2
3	PHASE W SENSE	Source of HS W and Drain of LS W
4	GATE HS W	Gate of HS phase W MOSFET
5	GATE LS W	Gate of LS phase W MOSFET
6	PHASE V SENSE	Source of HS V and Drain of LS V
7	GATE HS V	Gate of HS phase V MOSFET
8	GATE LS V	Gate of LS phase V MOSFET
9	PHASE U SENSE	Source of HS U and Drain of LS U
10	GATE HS U	Gate of HS phase U MOSFET
11	VBAT SENSE	Drain of HS U, V and W MOSFET
12	GATE LS U	Gate of LS phase U MOSFET
13	SHUNT P	Source of LS U, V W MOSFETS / Shunt +
14	SHUNT N	Negative shunt terminal (shunt –)
15	VBAT	Positive battery terminal
16	GND	Negative battery terminal
17	PHASE U	Motor phase U
18	PHASE V	Motor phase V
19	PHASE W	Motor phase W

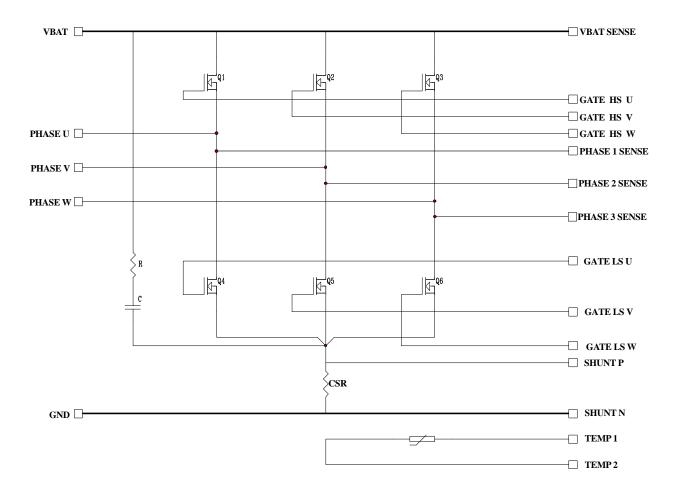


Figure 2. Internal Equivalent Circuit

ELECTRICAL CHARACTERISTICS (T_J = 25°C, Unless Otherwise Specified)

Symbol	Parameter	Test Condition	Min	Тур	Max	Unit
BVpss	D-S Breakdown Voltage (Inverter MOSFETs)	$V_{GS} = 0$, $I_D = 250 \mu A$	40	-	-	V
Vgs	Gate to Source Voltage (Inverter MOSFETs)		-20	_	20	V
Vтн	Threshold Voltage (Inverter MOSFETs)	$V_{GS} = V_{DS}, I_D = 250 \mu A, T_j = 25^{\circ}C$	2.0	2.8	4.0	V
Vsp	MOSFET Body Diode Forward Voltage	$V_{GS} = 0 \text{ V}, I_S = 80 \text{ A}, T_j = 25^{\circ}\text{C}$		0.8	1.28	V
RDS(ON)Q1	Inverter High Side MOSFETs Q1 (See Note 3)	$V_{GS} = 10 \text{ V}, I_D = 80 \text{ A}, T_j = 25^{\circ}\text{C}$	-	1.15	1.66	mΩ
RDS(ON)Q2	Inverter High Side MOSFETs Q2 (See Note 3)	$V_{GS} = 10 \text{ V}, I_D = 80 \text{ A}, T_j = 25^{\circ}\text{C}$	-	1.22	1.73	mΩ
RDS(ON)Q3	Inverter High Side MOSFETs Q3 (See Note 3)	$V_{GS} = 10 \text{ V}, I_D = 80 \text{ A}, T_j = 25^{\circ}\text{C}$	-	1.31	1.82	mΩ
RDS(ON)Q4	Inverter Low Side MOSFETs Q4 (See Note 3)	$V_{GS} = 10 \text{ V}, I_D = 80 \text{ A}, T_j = 25^{\circ}\text{C}$	-	1.36	1.87	mΩ
RDS(ON)Q5	Inverter Low Side MOSFETs Q5 (See Note 3)	$V_{GS} = 10 \text{ V}, I_D = 80 \text{ A}, T_j = 25^{\circ}\text{C}$	-	1.57	2.08	mΩ
RDS(ON)Q6	Inverter Low Side MOSFETs Q6 (See Note 3)	$V_{GS} = 10 \text{ V}, I_D = 80 \text{ A}, T_j = 25^{\circ}\text{C}$	-	1.86	2.32	mΩ
IDSS	Inverter MOSFETs (UH,UL,VH,VL,WH,WL)	$V_{GS} = 0 \text{ V}, V_{DS} = 32 \text{ V}, T_j = 25^{\circ}\text{C}$	_	-	1.0	μΑ
Igss	Inverter MOSFETs Gate to Source Leakage Current	V _{GS} = ±20 V	_	-	±100	nA
Total lo	op resistance VLINK(+) – V0 (–)	$V_{GS} = 10 \text{ V}, I_D = 80 \text{ A}, T_j = 25^{\circ}\text{C}$	-	4.69	5.5	mΩ

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product

TEMPERATURE SENSE (NTC Thermistor)

Symbol	Test Conditions	Test Time	Min	Тур	Max	Unit
Voltage	Current = 1 mA, Temperature = 25°C	T = 0.5 ms	7.5	1	12	V

CURRENT SENSE RESISTOR

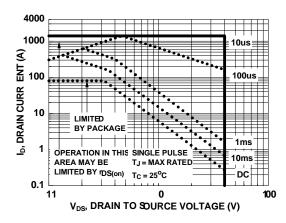
Symbol	Test Conditions	Test Time	Min	Тур	Max	Unit
Resistance	Current Sense resistor current = 80 A	T = 0.5 ms	0.46	-	0.53	mΩ

performance may not be indicated by the Electrical Characteristics for the listed test conditions, thress otherwise noted. I roduct performance may not be indicated by the Electrical Characteristics if operated under different conditions.

3. All MOSFETs have same die size and R_{DS(ON)}. The different R_{DS(ON)} values listed in the datasheet are due to the different access points available inside the module for R_{DS(ON)} measurement. While the high side MOSFETs (Q1, Q2, Q3) have source sense wire bonds, the low side MOSFETs (Q4, Q5, Q6) do not have source sense wire bonds, thus resulting in higher R_{DS(ON)} values.

TYPICAL CHARACTERISTICS

(Generated using MOSFETs assembled in a TO263 package, for reference purposes only.)

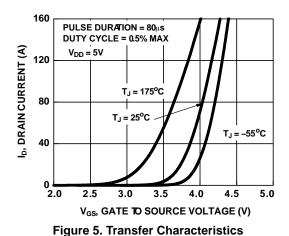


 $\underbrace{ \underbrace{ \underbrace{ \underbrace{ \text{V}_{AS}}_{AV} = (L)(I_{AS})/(1.3^* \text{RATED BV}_{DSS} - V_{DD}) }_{t_{AV} = (L)(I_{AS})/(1.3^* \text{RATED BV}_{DSS} - V_{DD}) + 1] } }_{0.01} \underbrace{ \underbrace{ \underbrace{ \underbrace{ \text{V}_{AS}}_{AV} = (L/R) \ln[(I_{AS}^*R)/(1.3^* \text{RATED BV}_{DSS} - V_{DD}) + 1] }_{t_{AV} = (L/R) \ln[(I_{AS}^*R)/(1.3^* \text{RATED BV}_{DSS} - V_{DD}) + 1] } }_{0.01} \underbrace{ \underbrace{ \underbrace{ \text{V}_{AS}}_{AV} = 25^\circ \text{C} }_{t_{AV}} }_{t_{AV} = 150^\circ \text{C}} \underbrace{ \underbrace{ \text{V}_{AS}}_{AV} = 25^\circ \text{C} }_{t_{AV} = 150^\circ \text{C}} \underbrace{ \underbrace{ \text{V}_{AS}}_{AV} = 150^\circ \text{C} }_{t_{AV} = 150^\circ \text{C}} \underbrace{ \underbrace{ \text{V}_{AS}}_{AV} = 150^\circ \text{C} }_{t_{AV} = 150^\circ \text{C}} \underbrace{ \underbrace{ \text{V}_{AS}}_{AV} = 150^\circ \text{C} }_{t_{AV} = 150^\circ \text{C}} \underbrace{ \underbrace{ \text{V}_{AS}}_{AV} = 150^\circ \text{C} }_{t_{AV} = 150^\circ \text{C}} \underbrace{ \underbrace{ \text{V}_{AS}}_{AV} = 150^\circ \text{C} }_{t_{AV} = 150^\circ \text{C}} \underbrace{ \underbrace{ \text{V}_{AS}}_{AV} = 150^\circ \text{C} }_{t_{AV} = 150^\circ \text{C}} \underbrace{ \underbrace{ \text{V}_{AS}}_{AV} = 150^\circ \text{C} }_{t_{AV} = 150^\circ \text{C}} \underbrace{ \underbrace{ \text{V}_{AS}}_{AV} = 150^\circ \text{C} }_{t_{AV} = 150^\circ \text{C}} \underbrace{ \underbrace{ \text{V}_{AS}}_{AV} = 150^\circ \text{C} }_{t_{AV} = 150^\circ \text{C}} \underbrace{ \underbrace{ \text{V}_{AS}}_{AV} = 150^\circ \text{C} }_{t_{AV} = 150^\circ \text{C}} \underbrace{ \underbrace{ \text{V}_{AS}}_{AV} = 150^\circ \text{C} }_{t_{AV} = 150^\circ \text{C}} \underbrace{ \underbrace{ \text{V}_{AS}}_{AV} = 150^\circ \text{C} }_{t_{AV} = 150^\circ \text{C}} \underbrace{ \underbrace{ \text{V}_{AS}}_{AV} = 150^\circ \text{C} }_{t_{AV} = 150^\circ \text{C}} \underbrace{ \underbrace{ \text{V}_{AS}}_{AV} = 150^\circ \text{C} }_{t_{AV} = 150^\circ \text{C}} \underbrace{ \underbrace{ \text{V}_{AS}}_{AV} = 150^\circ \text{C} }_{t_{AV} = 150^\circ \text{C}} \underbrace{ \underbrace{ \text{V}_{AS}}_{AV} = 150^\circ \text{C} }_{t_{AV} = 150^\circ \text{C}} \underbrace{ \underbrace{ \text{V}_{AS}}_{AV} = 150^\circ \text{C} }_{t_{AV} = 150^\circ \text{C}} \underbrace{ \underbrace{ \text{V}_{AS}}_{AV} = 150^\circ \text{C} }_{t_{AV} = 150^\circ \text{C}} \underbrace{ \underbrace{ \text{V}_{AS}}_{AV} = 150^\circ \text{C} }_{t_{AV} = 150^\circ \text{C}} \underbrace{ \underbrace{ \text{V}_{AS}}_{AV} = 150^\circ \text{C} }_{t_{AV} = 150^\circ \text{C}} \underbrace{ \underbrace{ \text{V}_{AS}}_{AV} = 150^\circ \text{C} }_{t_{AV} = 150^\circ \text{C}} \underbrace{ \underbrace{ \text{V}_{AS}}_{AV} = 150^\circ \text{C} }_{t_{AV} = 150^\circ \text{C}} \underbrace{ \underbrace{ \text{V}_{AS}}_{AV} = 150^\circ \text{C} }_{t_{AV} = 150^\circ \text{C}} \underbrace{ \underbrace{ \text{V}_{AS}}_{AV} = 150^\circ \text{C} }_{t_{AV} = 150^\circ \text{C}} \underbrace{ \underbrace{ \text{V}_{AS}}_{AV} = 150^\circ \text{C} }_{t_{AV} = 150^\circ \text{C}} \underbrace{ \underbrace{ \text{V}_{AS}}_{AV} = 150^\circ \text{C} }_{t_{AV} = 150^\circ \text{C}} \underbrace{ \underbrace{ \text{V}_{AS}}_{AV} =$

Figure 3. Forward Bias Safe Operating Area

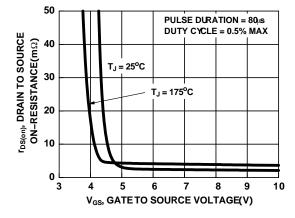
NOTE: Refer to Application Notes AN7514 and AN7515

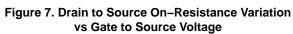
Figure 4. Unclamped Inductive Switching Capability



160 V_{GS} = 10V PULSE DURATION = $80\mu s$ V_{GS} = 5V DUTY CYCLE = 0.5% MAX ID, DRAIN CURRENT (A) 120 V_{GS} = 4.5V 80 $V_{GS} = 4V$ 40 $V_{GS} = 3.5V$ 0 2 3 0 V_{DS}, DRAIN TO SOURCE VOLTAGE (V)

Figure 6. Saturation Characteristics





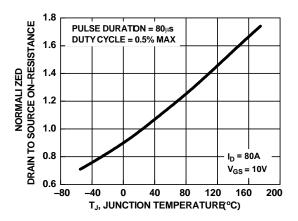


Figure 8. Normalized Drain to Source On Resistance vs Junction Temperature

TYPICAL CHARACTERISTICS

(Generated using MOSFETs assembled in a TO263 package, for reference purposes only.)

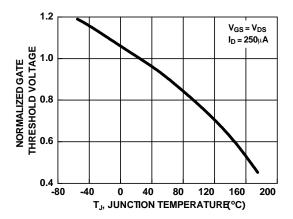


Figure 9. Normalized Gate Threshold Voltage vs Junction Temperature

Figure 10. Normalized Drain to Source Breakdown Voltage vs Junction Temperature

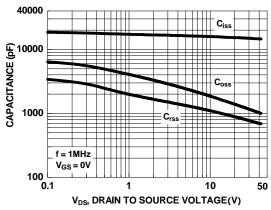


Figure 11. Capacitance vs Drain to Source Voltage

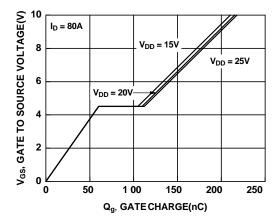
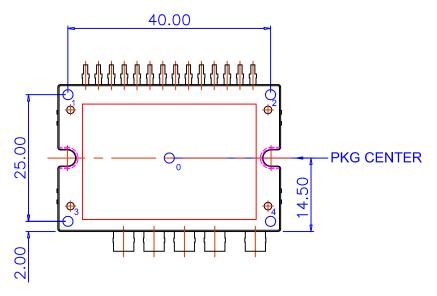


Figure 12. Gate Charge vs Gate to Source Voltage

MECHANICAL CHARACTERISTICS AND RATINGS

		Limits			
Parameter	Condition	Min	Тур	Max	Unit
Device Flatness	Note Figure 13.	0	_	+200	μm
Mounting Torque	Mounting Screw: – M3, Recommended 0.7 N.m	0.6	0.7	0.8	N.m
Weight		_	20	-	g



FLATNESS: MAX. 200um

-. MEASURING AT INDICATING POINTS1, 2, 3, AND 4 (BASED ON "0")

Figure 13. Flatness Measurement Position

ORDERING INFORMATION

Device Marking	MOSFET	Packing Type	Quantity
FTCO3V455A1	PCF33478	Tube	11

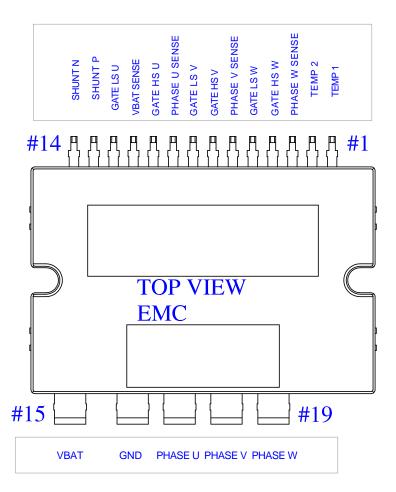
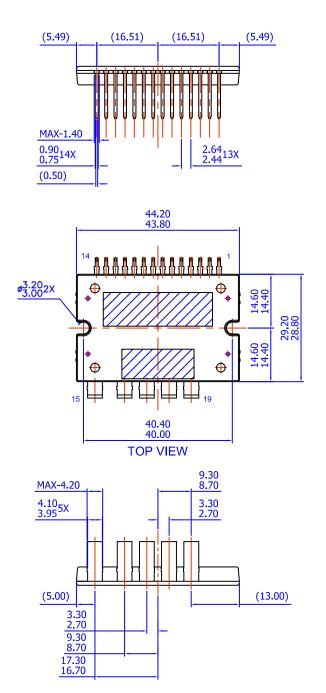
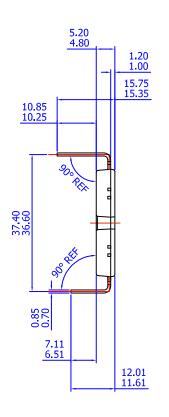


Figure 14.

APMCB-A19 / 19LD, APM, PDD STD DBC, DIP TYPE CASE MODCG ISSUE O

DATE 31 DEC 2016





NOTES: UNLESS OTHERWISE SPECIFIED

A) THIS PACKAGE DOES NOT COMPLY

TO ANY CURRENT PACKAGING STANDARD

B) ALL DIMENSIONS ARE IN MILLIMETERS

C) DIMENSIONS ARE EXCLUSIVE OF BURRS,

MOLD FLASH, AND TIE BAR EXTRUSIONS

D) () IS REFERENCE

DOCUMENT NUMBER:	98AON13507G	Electronic versions are uncontrolled except when accessed directly from the Document Repos Printed versions are uncontrolled except when stamped "CONTROLLED COPY" in red.		
DESCRIPTION:	APMCB-A19 / 19LD, APM,	PMCB-A19 / 19LD, APM, PDD STD DBC, DIP TYPE		

ON Semiconductor and are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. ON Semiconductor does not convey any license under its patent rights nor the rights of others.

onsemi, ONSEMI, and other names, marks, and brands are registered and/or common law trademarks of Semiconductor Components Industries, LLC dba "onsemi" or its affiliates and/or subsidiaries in the United States and/or other countries. onsemi owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of onsemi's product/patent coverage may be accessed at www.onsemi.com/site/pdf/Patent-Marking.pdf. Onsemi reserves the right to make changes at any time to any products or information herein, without notice. The information herein is provided "as-is" and onsemi makes no warranty, representation or guarantee regarding the accuracy of the information, product features, availability, functionality, or suitability of its products for any particular purpose, nor does onsemi assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using onsemi products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications provided by onsemi. "Typical" parameters which may be provided in onsemi data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. onsemi does not convey any license under any of its intellectual property rights nor the rights of others. onsemi products are not designed, intended, or authorized for use as a critical component in life support systems or any EDA class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer pu

PUBLICATION ORDERING INFORMATION

LITERATURE FULFILLMENT:
Email Requests to: orderlit@onsemi.com

onsemi Website: www.onsemi.com

TECHNICAL SUPPORT North American Technical Support: Voice Mail: 1 800-282-9855 Toll Free USA/Canada Phone: 011 421 33 790 2910

Europe, Middle East and Africa Technical Support:

a Phone: 00421 33 790 2910

For additional information, please contact your local Sales Representative

X-ON Electronics

Largest Supplier of Electrical and Electronic Components

Click to view similar products for Motor/Motion/Ignition Controllers & Drivers category:

Click to view products by ON Semiconductor manufacturer:

Other Similar products are found below:

FSB50550TB2 FSBF15CH60BTH MSVCPM2-63-12 MSVGW45-14-2 MSVGW54-14-3 MSVGW54-14-5 NTE7043 LA6565VR-TLM-E LB11650-E LB1837M-TLM-E LB1845DAZ-XE LC898300XA-MH SS30-TE-L-E 26700 LV8281VR-TLM-H BA5839FP-E2 IRAM236-1067A LA6584JA-AH LB11847L-E NCV70501DW002R2G AH293-PL-B STK672-630CN-E TND315S-TL-2H FNA23060 FSB50250AB FNA41060 MSVB54 MSVBTC50E MSVCPM3-54-12 MSVCPM3-63-12 MSVCPM4-63-12 MSVTA120 FSB50550AB NCV70501DW002G LC898301XA-MH LV8413GP-TE-L-E MSVGW45-14-3 MSVGW45-14-4 MSVGW45-14-5 MSVGW54-14-4 STK984-091A-E MP6519GQ-Z LB11651-E IRSM515-025DA4 LV8127T-TLM-H MC33812EKR2 NCP81382MNTXG TDA21801 LB11851FA-BH NCV70627DQ001R2G